ROHM EMG5 / UMG5N

Emitter common (dual digital transistor)

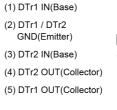
Parameter	DTr1 and DTr2
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	10kΩ
R <sub>2</sub>	47kΩ

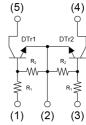
## 

### Features

- 1)Two DTC114Y chips in a EMT or UMT package
- 2)Mounting cost and area can be cut in half.

## Inner circuit





## • Application INVERTER, INTERFACE, DRIVER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMG5	SOT-553 (EMT5)	1616	T2R	180	8	8000	G5
UMG5N	SOT-353 (UMT5)	2021	TR	180	8	3000	G5

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

## <For DTr1 and DTr2 in common>

Parameter		Symbol	Values	Unit		
Supply voltage		V <sub>CC</sub>	50	V		
Input voltage		V <sub>IN</sub>	-6 to 40	V		
Output current		I <sub>o</sub>	70	mA		
Collector current		I <sub>C(MAX)</sub> *1	100	mA		
Deven die ein etien	EMG5		P <sub>D</sub> <sup>*2*3</sup>	150	-mW/Total	
Power dissipation	UMG5N		P <sub>D</sub> <sup>*2*3</sup>	150		
Junction temperature		Tj	150	°C		
Range of storage temperature		T <sub>stg</sub>	-55 to +150	°C		

## • Electrical characteristics (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

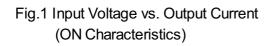
Deremeter	Cumphal	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Innutvaltara	V <sub>I(off)</sub>	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100µA	-	-	0.3	V	
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 1mA	1.4	-	-	V	
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 5mA, I <sub>I</sub> = 0.25mA	-	100	300	mV	
Input current	I <sub>I</sub>	V <sub>1</sub> = 5V	-	-	880	μA	
Output current	I <sub>O(off)</sub>	$V_{CC} = 50V, V_{I} = 0V$	-	-	500	nA	
DC current gain	G <sub>I</sub>	V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA	68	-	-	-	
Input resistance	R <sub>1</sub>	-	7	10	13	kΩ	
Resistance ratio	$R_2/R_1$	-	3.7	4.7	5.7	-	
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz	

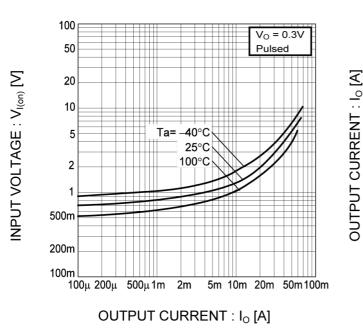
\*1 Characteristics of built-in transistor.

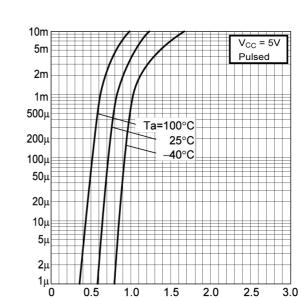
\*2 Each terminal mounted on a reference land.

\*3 120mW per element must not be exceeded.

## •Electrical characteristic curves (T<sub>a</sub> = 25°C) <For DTr1 and DTr2 in common>



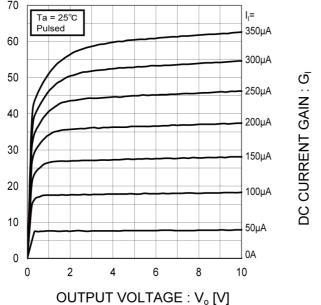




# Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

Fig.4 DC Current Gain vs. Output Current

INPUT VOLTAGE :  $V_{I(off)}$  [V]



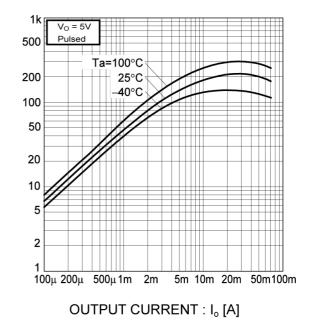


Fig.3 Output Current vs. Output Voltage



## • Electrical characteristic curves ( $T_a = 25^{\circ}C$ )

<For DTr1 and DTr2 in common>

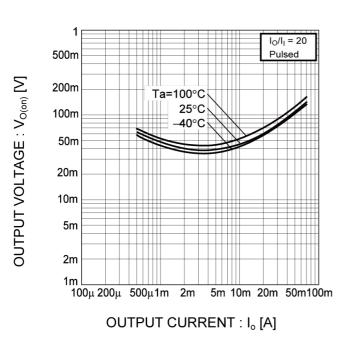
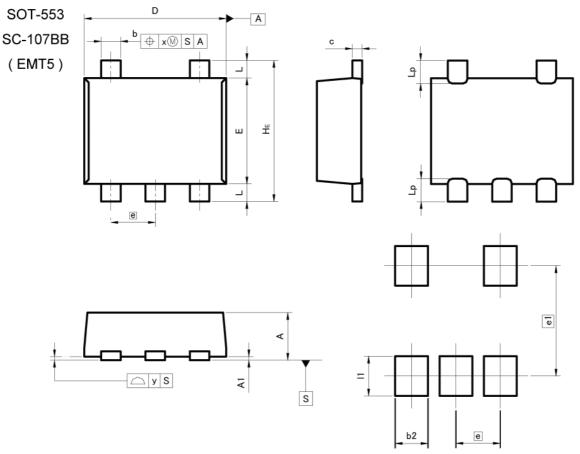


Fig.5 Output Voltage vs. Output Current



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

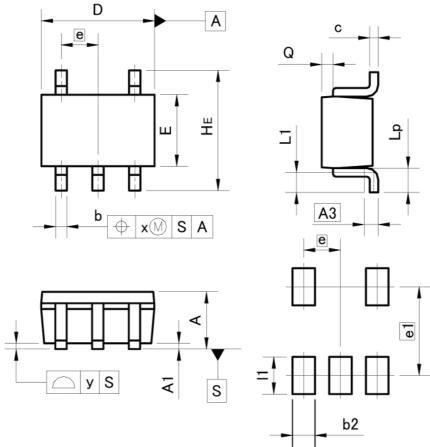
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
с	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.50		0.0	20
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	-	0.35	-	0.014
x	-	0.10	-	0.004
У	-	0.10	-	0.004
DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	-	0.015
e1	1.25		0.049	
1	-	0.45	Ξ	0.018

Dimension in mm/inches



## Dimensions





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIN	MIN	MAX	MIN	MAX	
A	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.	25	0.0	10	
b	0.15	0.30	0.006	0.012	
с	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
Е	1.15	1.35	0.045	0.053	
е	0.65		0.026		
He	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.020	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
х	-	0.10	-	0.004	
У	-	0.10	-	0.004	
DIM	MILIM	ETERS	INC	HES	
DIM	MIN	МАХ	MIN	MAX	

DIM	MILIM	MILIMETERS		HES
MIN MA		MAX	MIN	MAX
b2	- 1	0.40	-	0.016
e1	1.55		0.061	
1	- 0.65		-	0.026

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications
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	JAPAN	USA	EU	CHINA
	CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
	CLASSⅣ	CLASSIII	CLASSⅢ	CLASSII

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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